



re the Application of: ISHIDA, Hideki, et al. Attention: Applications Division

Serial Number: 10/533,524

Group Art Unit: 2831

Filed: May 2, 2005

P.T.O. Confirmation No.: 1622

For:

SOLID ELECTROLYTIC CAPACITOR AND MOUNTING METHOD

**THEREFOR** 

# REQUEST FOR CORRECTED FILING RECEIPT

Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

Date: October 25, 2005

Sir:

Please supply the undersigned attorney with a corrected filing receipt for the aboveidentified application. The undersigned also respectfully requests that the Patent and Trademark Office records be amended to reflect the correction.

In reviewing the official Filing Receipt, we noted an error in that the title is incorrect and should read as --SOLID ELECTROLYTIC CAPACITOR AND MOUNTING METHOD THEREFOR- -. A copy of the Declaration is enclosed which indicates the correct information. We are enclosing a copy of the filing receipt with the corrections highlighted.

In the event that any fees are required in connection with this paper, please charge our Deposit Account No. 01-2340.

Respectfully submitted,

ARMSTRONG, KRATZ, QUINTOS,

HANSON & BROOKS, LLP

Donald W. Hanson Attorney for Applicants Reg. No. 27,133

DWH/bjb Atty. Docket No. **050184** Suite 1000 1725 K Street, N.W. Washington, D.C. 20006 (202) 659-2930

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PATENT TRADEMARK OFFICE

Enclosures: Official Filing Receipt and Declaration

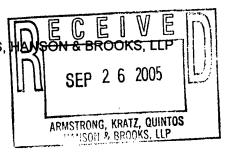


UNITED STATES DEPARTMENT OF COMMERCE United States Patent and Trademark Office Address: COMMISSIONER FOR PATENTS P.O. Box 1450 Alexandria, Vignia 22313-1450 www.uspto.gov

FILING OR 371 **TOT CLMS** IND CLMS **DRAWINGS** ATTY.DOCKET NO ART UNIT **FIL FEE REC'D** APPL NO. (c) DATE 050184 1260

10/533,524 05/02/2005 2831

23850 ARMSTRONG, KRATZ, QUINTOS. 1725 K STREET, NW **SUITE 1000** WASHINGTON, DC 20006



**CONFIRMATION NO. 1622** FILING RECEIPT

\*OC000000017045344\*

Date Mailed: 09/21/2005

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please mail to the Commissioner for Patents P.O. Box 1450 Alexandria Va 22313-1450. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

## Applicant(s)

Hideki Ishida, Hyogo, JAPAN; Eizo Fujii, Osaka, JAPAN; Yasuhiro Kishimoto, Tokyo, JAPAN; Hitoshi Ibuta, Osaka, JAPAN;

# **Assignment For Published Patent Application**

Sanyo Electric Co., Ltd., Moriguchi, Osaka, JAPAN

Power of Attorney: The patent practitioners associated with Customer Number 23850.

# Domestic Priority data as claimed by applicant

This application is a 371 of PCT/JP04/05179 04/09/2004

## **Foreign Applications**

JAPAN 2003-105589 04/09/2003

**Projected Publication Date: 12/29/2005** 

Non-Publication Request: No

Early Publication Request: No

Title

Solid-state electrolytic capacitor and mounting method therefor

-- Solid electrolytic lapacitor and mounting

Preliminary Class method therefor -
361

# PROTECTING YOUR INVENTION OUTSIDE THE UNITED STATES

Since the rights granted by a U.S. patent extend only throughout the territory of the United States and have no effect in a foreign country, an inventor who wishes patent protection in another country must apply for a patent in a specific country or in regional patent offices. Applicants may wish to consider the filing of an international application under the Patent Cooperation Treaty (PCT). An international (PCT) application generally has the same effect as a regular national patent application in each PCT-member country. The PCT process **simplifies** the filing of patent applications on the same invention in member countries, but **does not result** in a grant of "an international patent" and does not eliminate the need of applicants to file additional documents and fees in countries where patent protection is desired.

Almost every country has its own patent law, and a person desiring a patent in a particular country must make an application for patent in that country in accordance with its particular laws. Since the laws of many countries differ in various respects from the patent law of the United States, applicants are advised to seek guidance from specific foreign countries to ensure that patent rights are not lost prematurely.

Applicants also are advised that in the case of inventions made in the United States, the Director of the USPTO must issue a license before applicants can apply for a patent in a foreign country. The filing of a U.S. patent application serves as a request for a foreign filing license. The application's filing receipt contains further information and guidance as to the status of applicant's license for foreign filing.

Applicants may wish to consult the USPTO booklet, "General Information Concerning Patents" (specifically, the section entitled "Treaties and Foreign Patents") for more information on timeframes and deadlines for filing foreign patent applications. The guide is available either by contacting the USPTO Contact Center at 800-786-9199, or it can be viewed on the USPTO website at http://www.uspto.gov/web/offices/pac/doc/general/index.html.

For information on preventing theft of your intellectual property (patents, trademarks and copyrights), you may wish to consult the U.S. Government website, http://www.stopfakes.gov. Part of a Department of Commerce initiative, this website includes self-help "toolkits" giving innovators guidance on how to protect intellectual property in specific countries such as China, Korea and Mexico. For questions regarding patent enforcement issues, applicants may call the U.S. Government hotline at 1-866-999-HALT (1-866-999-4158).

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Title 35, United States Code, Section 184
Title 37, Code of Federal Regulations, 5.11 & 5.15

#### **GRANTED**

The applicant has been granted a license under 35 U.S.C. 184, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" followed by a date appears on this form. Such licenses are issued in all applications where the conditions for issuance of a license have been met, regardless of whether or not a license may be required as set forth in 37 CFR 5.15. The scope and limitations of this license are set forth in 37 CFR 5.15(a) unless an earlier license has been issued under 37 CFR 5.15(b). The license is subject to revocation upon written notification. The date indicated is the effective date of the license, unless an earlier license of similar scope has been granted under 37 CFR 5.13 or 5.14.

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## **NOT GRANTED**

No license under 35 U.S.C. 184 has been granted at this time, if the phrase "IF REQUIRED, FOREIGN FILING LICENSE GRANTED" DOES NOT appear on this form. Applicant may still petition for a license under 37 CFR 5.12, if a license is desired before the expiration of 6 months from the filing date of the application. If 6 months has lapsed from the filing date of this application and the licensee has not received any indication of a secrecy order under 35 U.S.C. 181, the licensee may foreign file the application pursuant to 37 CFR 5.15(b).

# **DECLARATION FOR U.S. PATENT APPLICATION**

As a below named inventor, I hereby declare that:

(Application Serial No.)

My residence, post office address and citizensh ip are as stated below next to my name.

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled:

SOLID F	ELECTROLYTIC CAPACITO	OR AND MOUNTING	METHOD THEREFOR	
the specification	on of which is attached hereto un	lless the following is cho	ecked	
was filed o	on APRIL 9, 2004 as United Sta	ates Application Numbe	r or PCT International	
Application	Number <u>PCT/JP2004/005179</u>	and was amended on _	(if applicable).	
	that I have reviewed and underst nended by any ame ndment refer		above -identified specification	, including the
I acknowledge Regulations, §	the duty to disclose information 1.56.	which is material to pa	tentability as defined in Title 3	7, Code of Federal
for patent or in	foreign priority benefits under I	and have also identified	below any foreign application	for patent or
(List prior foreign	ificate having a filing date before	e that of the application	for which priority is claim ed.	Priority Claimed
applications. See	2003-105589	Japan	9/4/2003	⊠ Yes □ No
note A)	(Number)	(Country)	(Day/Month/Year Filed)	
	(Number)	(Country)	(Day/Month/Year Filed)	☐ Yes ☐ No
	. ,	, ,,		
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
				☐ Yes ☐ No
	(Number)	(Country)	(Day/Month/Year Filed)	
See note B)	☐ See attached list for	additional prior foreign	applications	
nsofar as the s n the manner   nformation wh	the benefit under Title 35, Unite subject matter of each of the clair provided by the first paragraph onich is material to patentability a een the filing date of the prio	ns of this a pplication is of Title 35, United State is defined in Title 3 7, 0 r application and the	s not disclosed in the prior Units cs Code, § 112, I acknowledge Code of Federal Regulations,	ted States application the duty to disclose § 1.56 which became I filing date of this
	(Application Serial No.)	(Filing Date)	☐ Patented ☐ Pend	ing Abandoned
	(Application Serial No.)	(Filing Date)	Latented   Tend	
		•	Patented Pend	ing 🔲 Abandoned

(Filing Date)

I hereby appoint the following \_\_\_rney(s) and/or agent(s) to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith:

23850

Please direct all communications to the following address:

# 23850

I hereby declare that all statements made herein of my own knowledge are true and that a ll statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Title 18 of the United States Code, '1001 and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

note C)	Full name of sole or first inventor (given name, family name)		Hideki ISHIDA		
	Inventor's signature	Id Ochelia	Date 07/03/2005		
	Residence	Hyogo, Japan	Citizenship Japanese		
	Post Office Address	70-7, Kitaike, Amidacho, Takasago-sh	hi, Hyogo, Japan		
	Full name of second i	nventor (given name, family name)	ame) Eizo FUJII		
	Inventor's signature	E. Fujii	Date 07/03/2005		
	Residence	Osaka, Japan	Citizenship Japanese		
	Post Office Address				
		1-6-29, Tsudaekimae, Hirakata-shi, O	Junus, Jupus		
	Full name of third inventor (given name, family name)		Yasuhiro KISHIMOTO		
	Inventor's signature	J. Kishi moto	Date 10/03/2005		
	Residence	Tokyo, Japan	Citizenship Japanese		
	Post Office Address 1-15-3-301, Ningyocho, Nihonbashi, Chuo-ku, Tokyo, Japan				
	Full name of fourth inventor (given name, family name)		Hitoshi IBUTA		
	Inventor's signature	A. Minte	Date 07/03/2005		
	Residence	Osaka, Japan	Citizenship Japanese		
	Post Office Address	1-12-61, Souya, Hirakata-shi, Osaka, J	apan		
	Full name of fifth inve	ntor (given name, family name)			
•	Inventor's signature		Date		
	Residence		Citizenship		
	Post Office Address				

# NOTES

- A. Please list all foreign applications relatin g to the invention and check block, "yes" or "no".
- B. If more than 4 prior foreign applications, please check this box and attach a sheet listing the remaining prior foreign applications.
- C. For residence in the U.S., indicate <u>city and state</u>, for residence outside the U.S., indicate <u>city and country</u>. The "Post Office Address" must be an address acceptable by a Post Office for delivery of mail.